



BOTTOM SIDE SHOWN

1. ASSEMBLY BOARD PER IPC-A-610 (LATEST REVISION) STANDARD.
2. HANDLE MOISTURE SENSITIVE DEVICES (MSD) PER MANUFACTURE'S CALL OUT ON MSD LABEL. IF MSD LABEL IS MISSING OR NOT LEGIBLE THEN ALL PLASTIC PACKAGED COMPONENTS ARE TO BE CONSIDERED MSD LEVEL 6 AND USE EIA/JEP 113-A FOR HANDLING.
3. USE IPC-7711/7721 (LATEST REVISION) FOR ALL PCBA REWORK.

				MATL		DWN		ACRONICS 10-FEB-23				3065 BOWERS AVE	
				SPEC		CHKR						SANTA CLARA	
-	XX-XXX-XXXX					DSGN ENGR		TITLE		PCB ASSEMBLY			
DASH	NEXT ASSY	USED ON		FNSH		RELEASE							
APPLICATION								AGILEX I-SERIES FPGA DEVKIT					
<div>THIRD ANGLE PROJECTION</div> 		TOLERANCES: DEC .X ± DEC .XX ± .01 DEC .XXX ± .005 DEC .XXXX ± .002 FRACTIONS ± — ANGLES ± 1'				CONTRACT NO. XXXXXXX		SIZE		CAGE CODE	DWG NO.	REV	
								D		N/A	M17471-100	B2	
						SCALE: 1/1		SHEET 1 OF 1					